

Vorläufig
preliminary**Elektrische Eigenschaften / electrical properties****Höchstzulässige Werte / maximum rated values****Diode Gleichrichter/ diode rectifier**

Periodische Rückw. Spitzensperrspannung repetitive peak reverse voltage	$T_{vj} = 25^{\circ}\text{C}$	V_{RRM}	800	V
Durchlaßstrom Grenzeffektivwert pro Chip RMS forward current per chip	$T_C = 80^{\circ}\text{C}$	I_{FRMSM}	58	A
Gleichrichter Ausgang Grenzeffektivstrom maximum RMS current at Rectifier output	$T_C = 80^{\circ}\text{C}$	I_{RMSmax}	50	A
Stoßstrom Grenzwert surge forward current	$t_p = 10 \text{ ms}, T_{vj} = 25^{\circ}\text{C}$ $t_p = 10 \text{ ms}, T_{vj} = 150^{\circ}\text{C}$	I_{FSM}	448 358	A A
Grenzlastintegral I^2t - value	$t_p = 10 \text{ ms}, T_{vj} = 25^{\circ}\text{C}$ $t_p = 10 \text{ ms}, T_{vj} = 150^{\circ}\text{C}$	I^2t	1000 642	A^2s A^2s

Transistor Wechselrichter/ transistor inverter

Kollektor-Emitter-Sperrspannung collector-emitter voltage	$T_{vj} = 25^{\circ}\text{C}$	V_{CES}	600	V
Kollektor-Dauergleichstrom DC-collector current	$T_C = 65^{\circ}\text{C}$ $T_C = 25^{\circ}\text{C}$	$I_{C,nom.}$ I_C	15 19	A A
Periodischer Kollektor Spitzenstrom repetitive peak collector current	$t_p = 1 \text{ ms}, T_C = 65^{\circ}\text{C}$	I_{CRM}	30	A
Gesamt-Verlustleistung total power dissipation	$T_C = 25^{\circ}\text{C}$	P_{tot}	60	W
Gate-Emitter-Spitzenspannung gate-emitter peak voltage		V_{GES}	+/- 20V	V

Diode Wechselrichter/ diode inverter

Dauergleichstrom DC forward current		I_F	15	A
Periodischer Spitzenstrom repetitive peak forw. current	$t_p = 1 \text{ ms}$	I_{FRM}	30	A
Grenzlastintegral I^2t - value	$V_R = 0\text{V}, t_p = 10\text{ms}, T_{vj} = 125^{\circ}\text{C}$	I^2t	25	A^2s

Transistor Brems-Chopper/ transistor brake-chopper

Kollektor-Emitter-Sperrspannung collector-emitter voltage	$T_{vj} = 25^{\circ}\text{C}$	V_{CES}	600	V
Kollektor-Dauergleichstrom DC-collector current	$T_C = 65^{\circ}\text{C}$ $T_C = 25^{\circ}\text{C}$	$I_{C,nom.}$ I_C	15 19	A A
Periodischer Kollektor Spitzenstrom repetitive peak collector current	$t_p = 1 \text{ ms}, T_C = 65^{\circ}\text{C}$	I_{CRM}	30	A
Gesamt-Verlustleistung total power dissipation	$T_C = 25^{\circ}\text{C}$	P_{tot}	60	W
Gate-Emitter-Spitzenspannung gate-emitter peak voltage		V_{GES}	+/- 20V	V

Diode Brems-Chopper/ diode brake-chopper

Dauergleichstrom DC forward current		I_F	15	A
Periodischer Spitzenstrom repetitive peak forw. current	$t_p = 1 \text{ ms}$	I_{FRM}	30	A

prepared by: Thomas Passe

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approved by: R. Keggenhoff

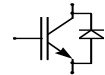
revision: 2.1

Technische Information / technical information

IGBT-Module
IGBT-Modules

FB15R06KL4B1

eupec



Vorläufig
preliminary

Modul Isolation/ module isolation

Isolations-Prüfspannung insulation test voltage	RMS, f = 50 Hz, t = 1 min. NTC connected to Baseplate	V_{ISOL}	2,5	kV
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Elektrische Eigenschaften / electrical properties

Charakteristische Werte / characteristic values

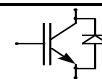
Diode Gleichrichter/ diode rectifier				min.	typ.	max.	
Durchlaßspannung forward voltage	$T_{vj} = 150^{\circ}\text{C},$	$I_F = 15 \text{ A}$	V_F	-	0,8	-	V
Schleusenspannung threshold voltage	$T_{vj} = 150^{\circ}\text{C}$		$V_{(TO)}$	-	0,61	-	V
Ersatzwiderstand slope resistance	$T_{vj} = 150^{\circ}\text{C}$		r_T	-	11	-	mΩ
Sperrstrom reverse current	$T_{vj} = 150^{\circ}\text{C},$	$V_R = 800 \text{ V}$	I_R	-	5	-	mA
Modul Leitungswiderstand, Anschlüsse-Chip lead resistance, terminals-chip	$T_C = 25^{\circ}\text{C}$		$R_{AA'+CC'}$	-	11	-	mΩ
Transistor Wechselrichter/ transistor inverter				min.	typ.	max.	
Kollektor-Emitter Sättigungsspannung collector-emitter saturation voltage	$V_{GE} = 15\text{V}, T_{vj} = 25^{\circ}\text{C}, I_C = 15 \text{ A}$	$V_{CE \text{ sat}}$	-	1,95	2,55	V	
	$V_{GE} = 15\text{V}, T_{vj} = 125^{\circ}\text{C}, I_C = 15 \text{ A}$		-	2,2	-	V	
Gate-Schwellenspannung gate threshold voltage	$V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}, I_C = 0,4\text{mA}$	$V_{GE(TO)}$	4,5	5,5	6,5	V	
Eingangskapazität input capacitance	$f = 1\text{MHz}, T_{vj} = 25^{\circ}\text{C}$ $V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}$	C_{ies}	-	0,8	-	nF	
Kollektor-Emitter Reststrom collector-emitter cut-off current	$V_{GE} = 0\text{V}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 600\text{V}$	I_{CES}	-	-	5,0	mA	
Gate-Emitter Reststrom gate-emitter leakage current	$V_{CE} = 0\text{V}, V_{GE} = 20\text{V}, T_{vj} = 25^{\circ}\text{C}$	I_{GES}	-	-	400	nA	
Einschaltverzögerungszeit (ind. Last) turn on delay time (inductive load)	$I_C = I_{Nenn}, V_{CC} = 300 \text{ V}$	$t_{d,on}$	-	37	-	ns	
	$V_{GE} = \pm 15\text{V}, T_{vj} = 25^{\circ}\text{C}, R_G = 68 \text{ Ohm}$						
	$V_{GE} = \pm 15\text{V}, T_{vj} = 125^{\circ}\text{C}, R_G = 68 \text{ Ohm}$						
Anstiegszeit (induktive Last) rise time (inductive load)	$I_C = I_{Nenn}, V_{CC} = 300 \text{ V}$	t_r	-	37	-	ns	
	$V_{GE} = \pm 15\text{V}, T_{vj} = 25^{\circ}\text{C}, R_G = 68 \text{ Ohm}$						
	$V_{GE} = \pm 15\text{V}, T_{vj} = 125^{\circ}\text{C}, R_G = 68 \text{ Ohm}$						
Abschaltverzögerungszeit (ind. Last) turn off delay time (inductive load)	$I_C = I_{Nenn}, V_{CC} = 300 \text{ V}$	$t_{d,off}$	-	216	-	ns	
	$V_{GE} = \pm 15\text{V}, T_{vj} = 25^{\circ}\text{C}, R_G = 68 \text{ Ohm}$						
	$V_{GE} = \pm 15\text{V}, T_{vj} = 125^{\circ}\text{C}, R_G = 68 \text{ Ohm}$						
Fallzeit (induktive Last) fall time (inductive load)	$I_C = I_{Nenn}, V_{CC} = 300 \text{ V}$	t_f	-	17	-	ns	
	$V_{GE} = \pm 15\text{V}, T_{vj} = 25^{\circ}\text{C}, R_G = 68 \text{ Ohm}$						
	$V_{GE} = \pm 15\text{V}, T_{vj} = 125^{\circ}\text{C}, R_G = 68 \text{ Ohm}$						
Einschaltverlustenergie pro Puls turn-on energy loss per pulse	$I_C = I_{Nenn}, V_{CC} = 300 \text{ V}$ $V_{GE} = \pm 15\text{V}, T_{vj} = 125^{\circ}\text{C}, R_G = 68 \text{ Ohm}$ $L_S = 80 \text{ nH}$	E_{on}	-	0,6	-	mJ	
Abschaltverlustenergie pro Puls turn-off energy loss per pulse	$I_C = I_{Nenn}, V_{CC} = 300 \text{ V}$ $V_{GE} = \pm 15\text{V}, T_{vj} = 125^{\circ}\text{C}, R_G = 68 \text{ Ohm}$ $L_S = 80 \text{ nH}$	E_{off}	-	0,4	-	mJ	
Kurzschlußverhalten SC Data	$t_P \leq 10\mu\text{s}, V_{GE} \leq 15\text{V}, R_G = 68 \text{ Ohm}$ $T_{vj} \leq 125^{\circ}\text{C}, V_{CC} = 360 \text{ V}$ $di/dt = 1000 \text{ A}/\mu\text{s}$	I_{SC}	-	60	-	A	

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Elektrische Eigenschaften / electrical properties

Charakteristische Werte / characteristic values

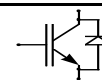
				min.	typ.	max.	
Modulinduktivität stray inductance module		$L_{\sigma CE}$	-	-	40	nH	
Modul Leitungswiderstand, Anschlüsse-Chip lead resistance, terminals-chip	$T_C = 25^\circ\text{C}$	$R_{CC'+EE'}$	-	10	-	mΩ	
Diode Wechselrichter/ diode inverter				min.	typ.	max.	
Durchlaßspannung forward voltage	$V_{GE} = 0\text{V}, T_{vj} = 25^\circ\text{C}, I_F = 15\text{A}$ $V_{GE} = 0\text{V}, T_{vj} = 125^\circ\text{C}, I_F = 15\text{A}$	V_F	-	1,75	2,15	V	
Rückstromspitze peak reverse recovery current	$I_F = I_{Nenn}, -di_F/dt = 600\text{A/us}$ $V_{GE} = -10\text{V}, T_{vj} = 25^\circ\text{C}, V_R = 300\text{V}$ $V_{GE} = -10\text{V}, T_{vj} = 125^\circ\text{C}, V_R = 300\text{V}$	I_{RM}	-	13	-	A	
Sperrverzögerungsladung recovered charge	$I_F = I_{Nenn}, -di_F/dt = 600\text{A/us}$ $V_{GE} = -10\text{V}, T_{vj} = 25^\circ\text{C}, V_R = 300\text{V}$ $V_{GE} = -10\text{V}, T_{vj} = 125^\circ\text{C}, V_R = 300\text{V}$	Q_r	-	0,8	-	μAs	
Abschaltenergie pro Puls reverse recovery energy	$I_F = I_{Nenn}, -di_F/dt = 600\text{A/us}$ $V_{GE} = -10\text{V}, T_{vj} = 25^\circ\text{C}, V_R = 300\text{V}$ $V_{GE} = -10\text{V}, T_{vj} = 125^\circ\text{C}, V_R = 300\text{V}$	E_{rec}	-	0,14	-	mJ	
Transistor Brems-Chopper/ transistor brake-chopper				min.	typ.	max.	
Kollektor-Emitter Sättigungsspannung collector-emitter saturation voltage	$V_{GE} = 15\text{V}, T_{vj} = 25^\circ\text{C}, I_C = 15,0\text{A}$ $V_{GE} = 15\text{V}, T_{vj} = 125^\circ\text{C}, I_C = 15,0\text{A}$	$V_{CE sat}$	-	1,95	2,55	V	
Gate-Schwellenspannung gate threshold voltage	$V_{CE} = V_{GE}, T_{vj} = 25^\circ\text{C}, I_C = 0,4\text{mA}$	$V_{GE(To)}$	4,5	5,5	6,5	V	
Eingangskapazität input capacitance	$f = 1\text{MHz}, T_{vj} = 25^\circ\text{C}$ $V_{CE} = 25\text{V}, V_{GE} = 0\text{V}$	C_{ies}	-	0,8	-	nF	
Kollektor-Emitter Reststrom collector-emitter cut-off current	$V_{GE} = 0\text{V}, T_{vj} = 25^\circ\text{C}, V_{CE} = 600\text{V}$		-	-	5,0	mA	
Gate-Emitter Reststrom gate-emitter leakage current	$V_{CE} = 0\text{V}, V_{GE} = 20\text{V}, T_{vj} = 25^\circ\text{C}$	I_{GES}	-	-	400	nA	
Diode Brems-Chopper/ diode brake-chopper				min.	typ.	max.	
Durchlaßspannung forward voltage	$T_{vj} = 25^\circ\text{C}, I_F = 15\text{A}$ $T_{vj} = 125^\circ\text{C}, I_F = 15\text{A}$	V_F	-	2,15	2,6	V	
			-	2,25	-	V	
NTC-Widerstand/ NTC-thermistor				min.	typ.	max.	
Nennwiderstand rated resistance	$T_C = 25^\circ\text{C}$	R_{25}	-	5	-	kΩ	
Abweichung von R_{100} deviation of R_{100}	$T_C = 100^\circ\text{C}, R_{100} = 493\ \Omega$	$\Delta R/R$	-5		5	%	
Verlustleistung power dissipation	$T_C = 25^\circ\text{C}$	P_{25}			20	mW	
B-Wert B-value	$R_2 = R_1 \exp [B(1/T_2 - 1/T_1)]$	$B_{25/50}$		3375		K	

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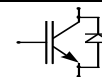
**Vorläufig
preliminary**

Thermische Eigenschaften / thermal properties

				min.	typ.	max.	
Innerer Wärmewiderstand thermal resistance, junction to heatsink	Gleichr. Diode/ rectif. diode	$\lambda_{\text{Paste}}=1\text{W/m}^2\text{K}$	R_{thJH}	-	1,1	-	K/W
	Trans. Wechselr./ trans. inverter	$\lambda_{\text{grease}}=1\text{W/m}^2\text{K}$		-	2,4	-	K/W
	Diode Wechselr./ diode inverter			-	4,0	-	K/W
	Trans. Bremse/ trans. brake			-	2,4	-	K/W
	Diode Bremse/ diode brake			-	4,3	-	K/W
Innerer Wärmewiderstand thermal resistance, junction to case	Gleichr. Diode/ rectif. diode		R_{thJC}	-	-	1	K/W
	Trans. Wechselr./ trans. inverter			-	-	2	K/W
	Diode Wechselr./ diode inverter			-	-	2,9	K/W
	Trans. Bremse/ trans. brake			-	-	2	K/W
	Diode Bremse/ diode brake			-	-	3,1	K/W
Übergangs-Wärmewiderstand thermal resistance, case to heatsink	Gleichr. Diode/ rectif. diode	$\lambda_{\text{Paste}}=1\text{W/m}^2\text{K}$	R_{thCH}	-	0,2	-	K/W
	Trans. Wechselr./ trans. inverter	$\lambda_{\text{grease}}=1\text{W/m}^2\text{K}$		-	0,6	-	K/W
	Diode Wechselr./ diode inverter			-	1,4	-	K/W
	Trans. Bremse/ trans. brake			-	0,6	-	K/W
	Diode Bremse/ diode brake			-	1,5	-	K/W
Höchstzulässige Sperrschichttemperatur maximum junction temperature			T_{vj}	-	-	150	°C
Betriebstemperatur operation temperature			T_{op}	-40	-	125	°C
Lagertemperatur storage temperature			T_{stg}	-40	-	125	°C

Mechanische Eigenschaften / mechanical properties

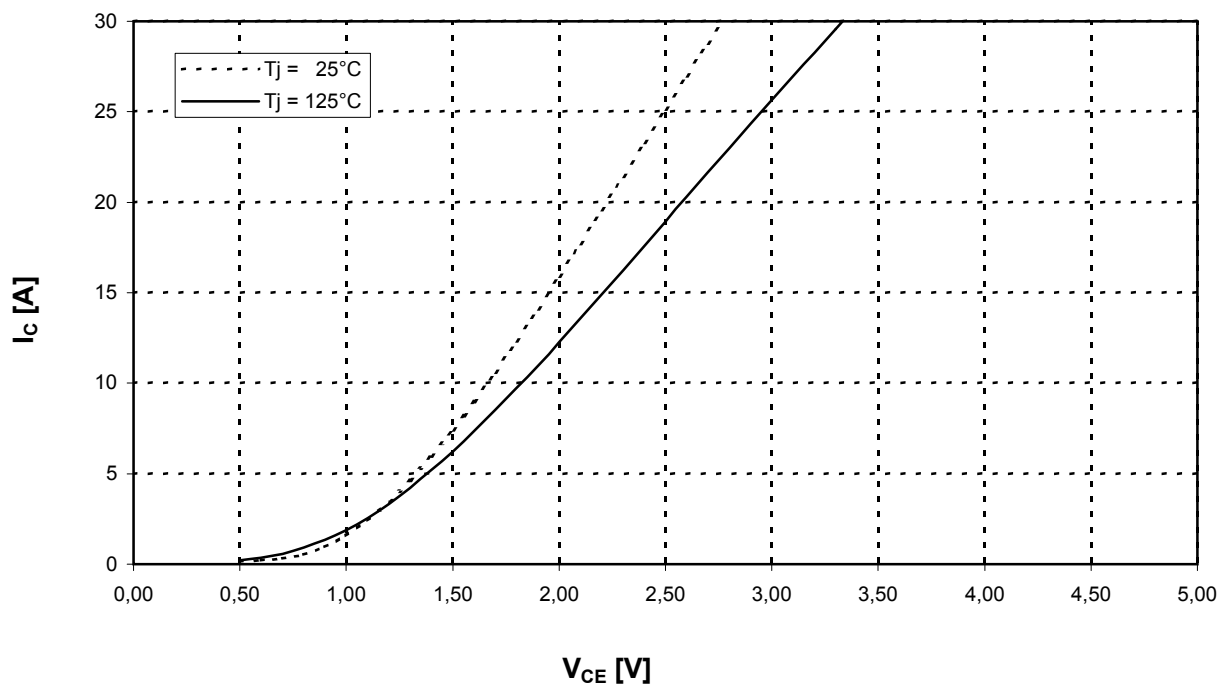
Innere Isolation internal insulation			Al_2O_3	
CTI comperative tracking index			225	
Anpreßkraft f. mech. Befestigung pro Feder mounting force per clamp		F	40...80	N
Gewicht weight		G	36	g
Kontakt - Kühlkörper terminal to heatsink	Kriechstrecke creepage distance		13,5	mm
	Luftstrecke clearance distance		12	mm
Terminal - Terminal terminal to terminal	Kriechstrecke creepage distance		7,5	mm
	Luftstrecke clearance distance		7,5	mm



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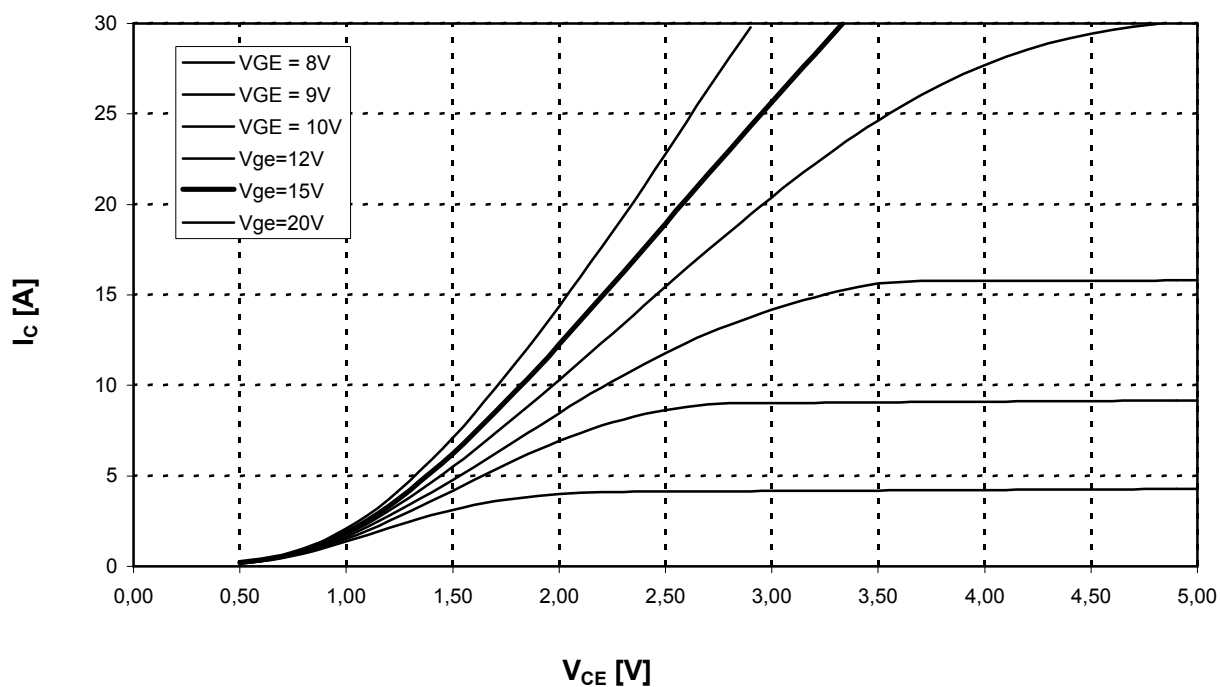
Ausgangskennlinienfeld Wechselr. (typisch)
output characteristic inverter (typical)

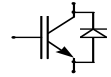
$I_C = f(V_{CE})$
 $V_{GE} = 15 \text{ V}$



Ausgangskennlinienfeld Wechselr. (typisch)
output characteristic inverter (typical)

$I_C = f(V_{CE})$
 $T_{vj} = 125^\circ\text{C}$

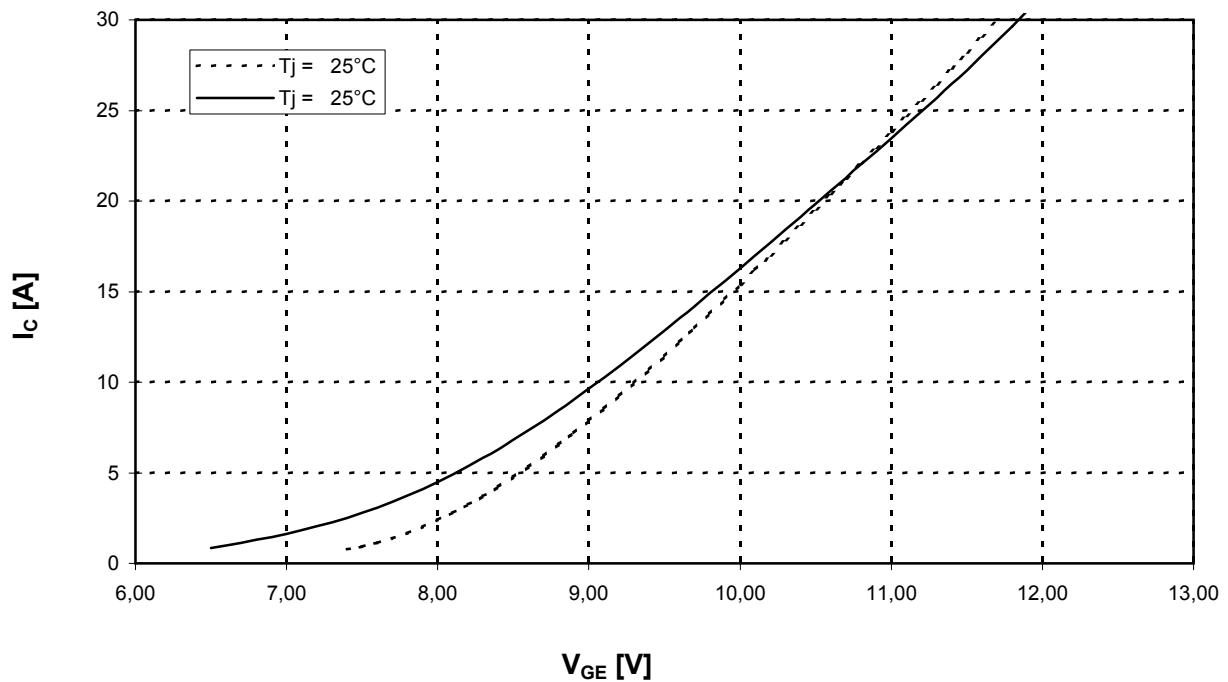


Vorläufig
preliminary

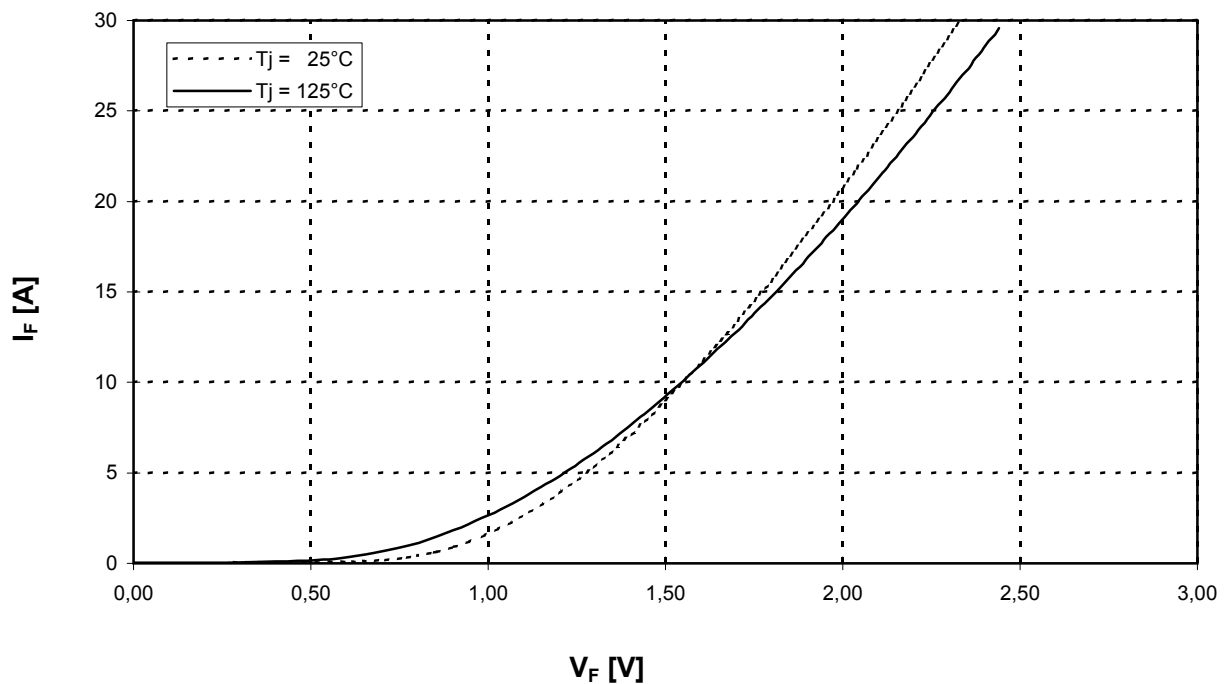
Übertragungscharakteristik Wechselr. (typisch)
transfer characteristic inverter (typical)

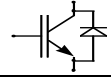
$$I_C = f(V_{GE})$$

$$V_{CE} = 20 \text{ V}$$

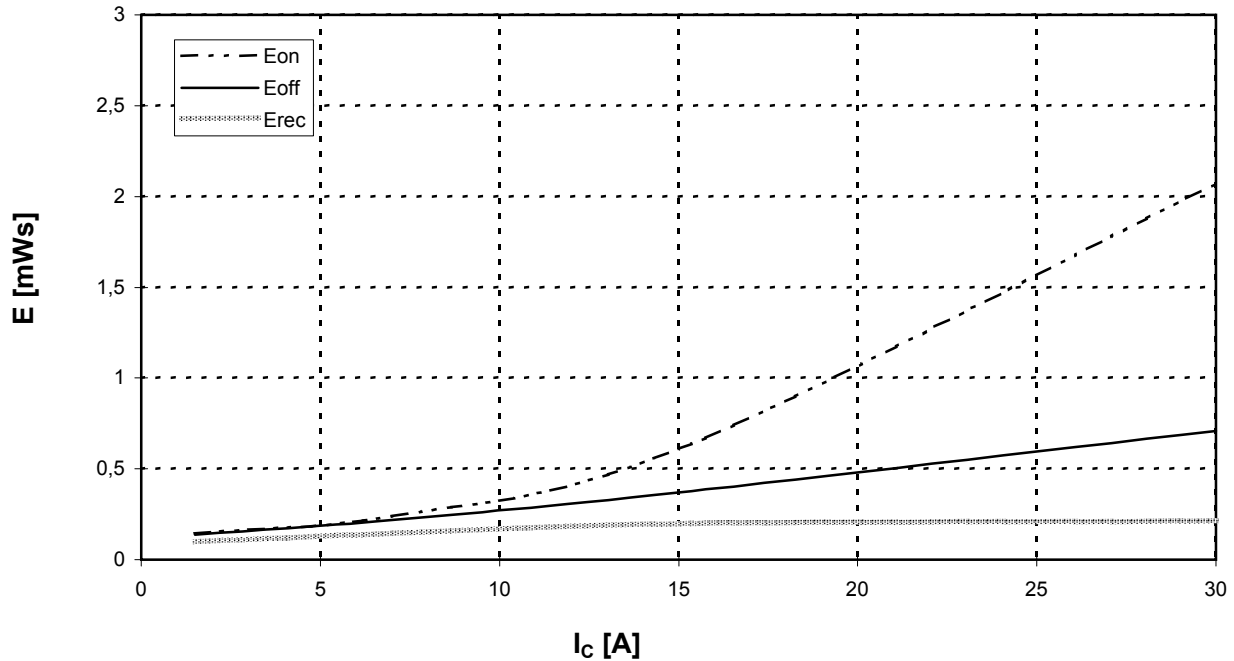


Durchlaßkennlinie der Freilaufdiode Wechselr. (typisch) $I_F = f(V_F)$
forward characteristic of FWD inverter (typical)

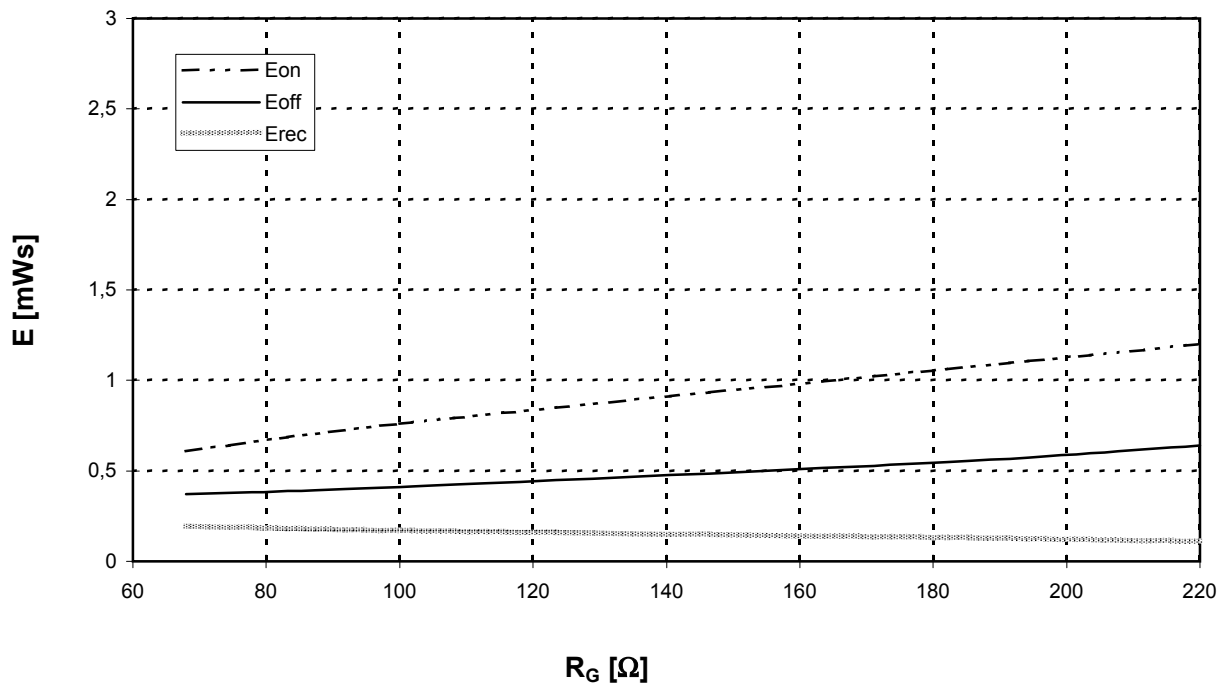


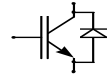
Vorläufig
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Schaltverluste Wechselr. (typisch) $E_{on} = f(I_c)$, $E_{off} = f(I_c)$, $E_{rec} = f(I_c)$ $V_{CC} = 300\text{ V}$
 switching losses inverter (typical) $T_j = 125^\circ\text{C}$, $V_{GE} = \pm 15\text{ V}$, $R_{Gon} = R_{Goff} = 68\text{ Ohm}$



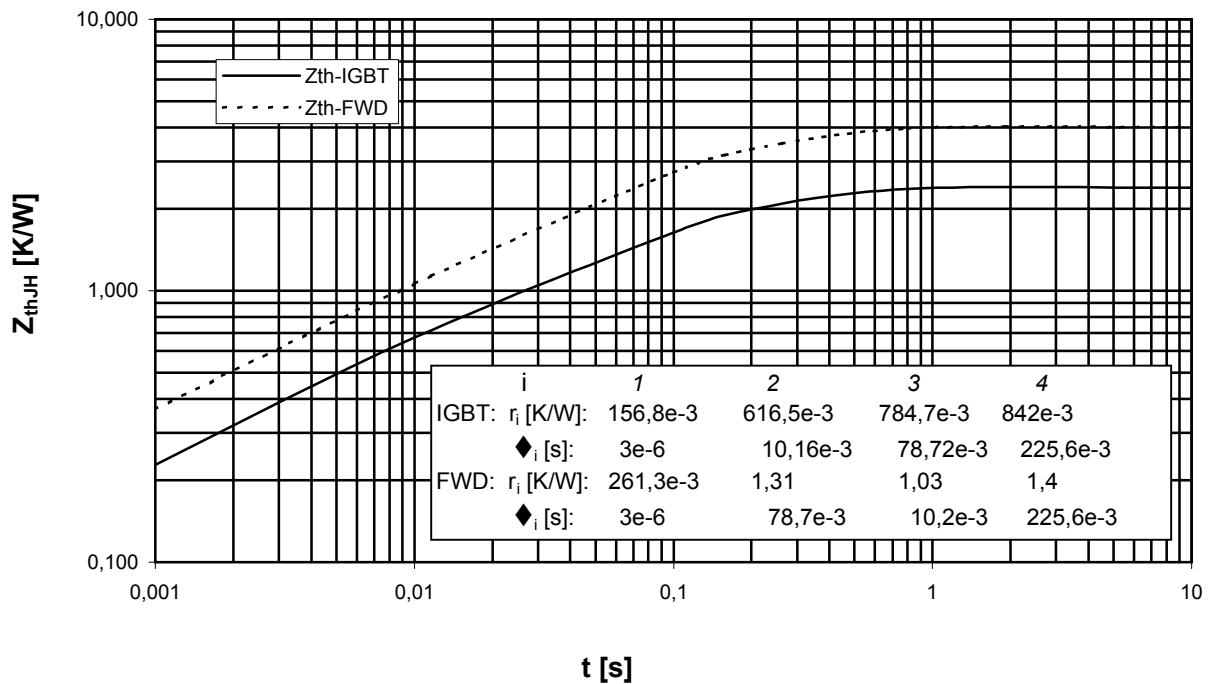
Schaltverluste Wechselr. (typisch) $E_{on} = f(R_G)$, $E_{off} = f(R_G)$, $E_{rec} = f(R_G)$
 switching losses inverter (typical) $T_j = 125^\circ\text{C}$, $V_{GE} = +15\text{ V}$, $I_c = I_{nenn}$, $V_{CC} = 300\text{ V}$



Vorläufig
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Transienter Wärmewiderstand Wechselr.
transient thermal impedance inverter

$$Z_{thJH} = f(t)$$

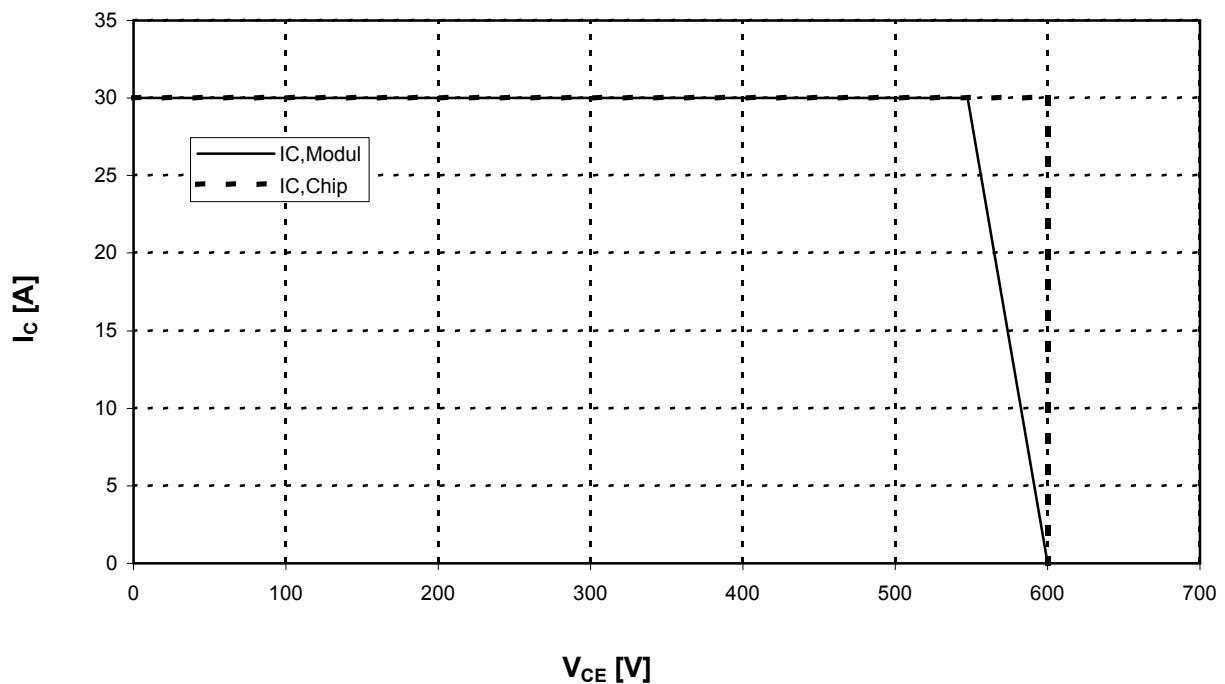


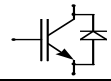
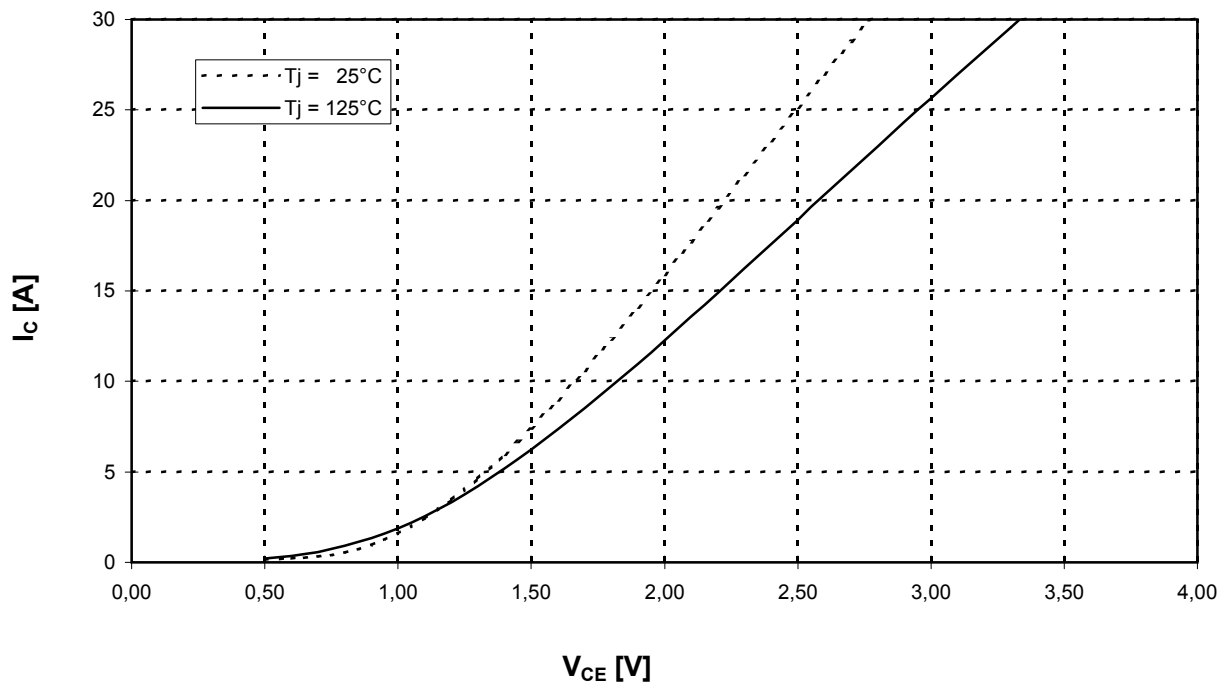
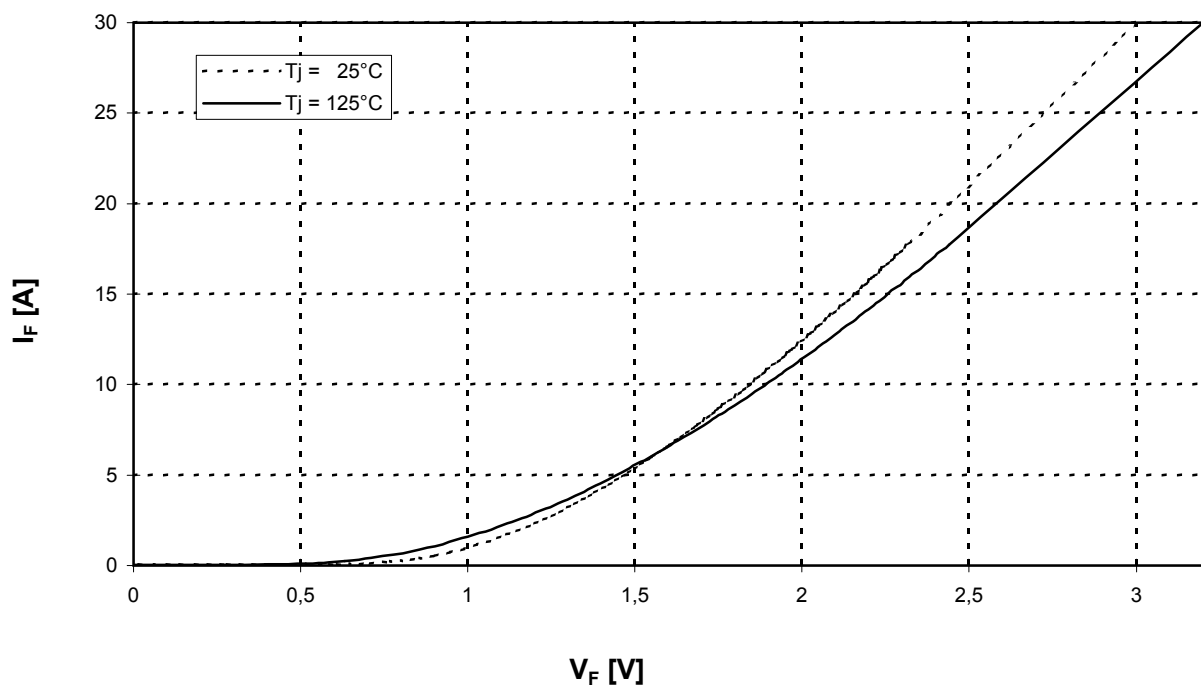
Sicherer Arbeitsbereich Wechselr. (RBSOA)

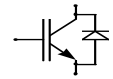
$$I_C = f(V_{CE})$$

reverse bias safe operating area inverter (RBSOA) $T_{vj} = 125^\circ\text{C}$, $V_{GE} = \pm 15\text{V}$, $R_G =$

68 Ohm



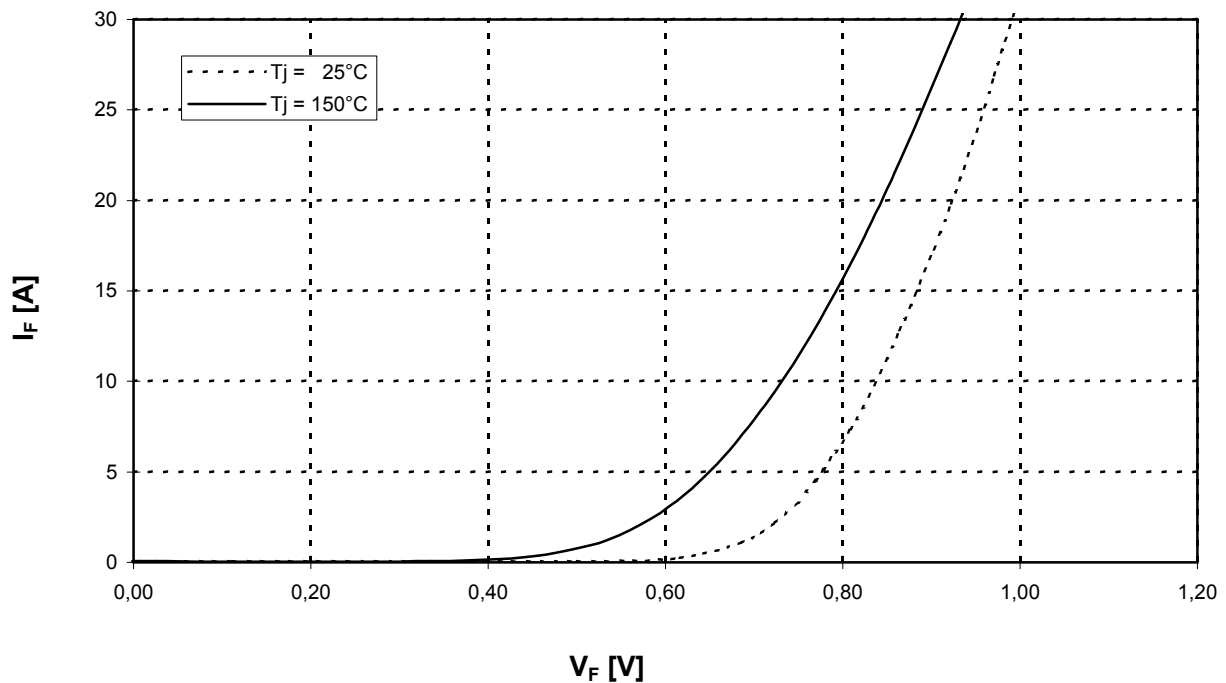
Vorläufig
preliminaryAusgangskennlinienfeld Brems-Chopper-IGBT (typisch)
output characteristic brake-chopper-IGBT (typical) $I_C = f(V_{CE})$
 $V_{GE} = 15\text{ V}$ Durchlaßkennlinie der Brems-Chopper-Diode (typisch) $I_F = f(V_F)$
forward characteristic of brake-chopper-FWD (typical)



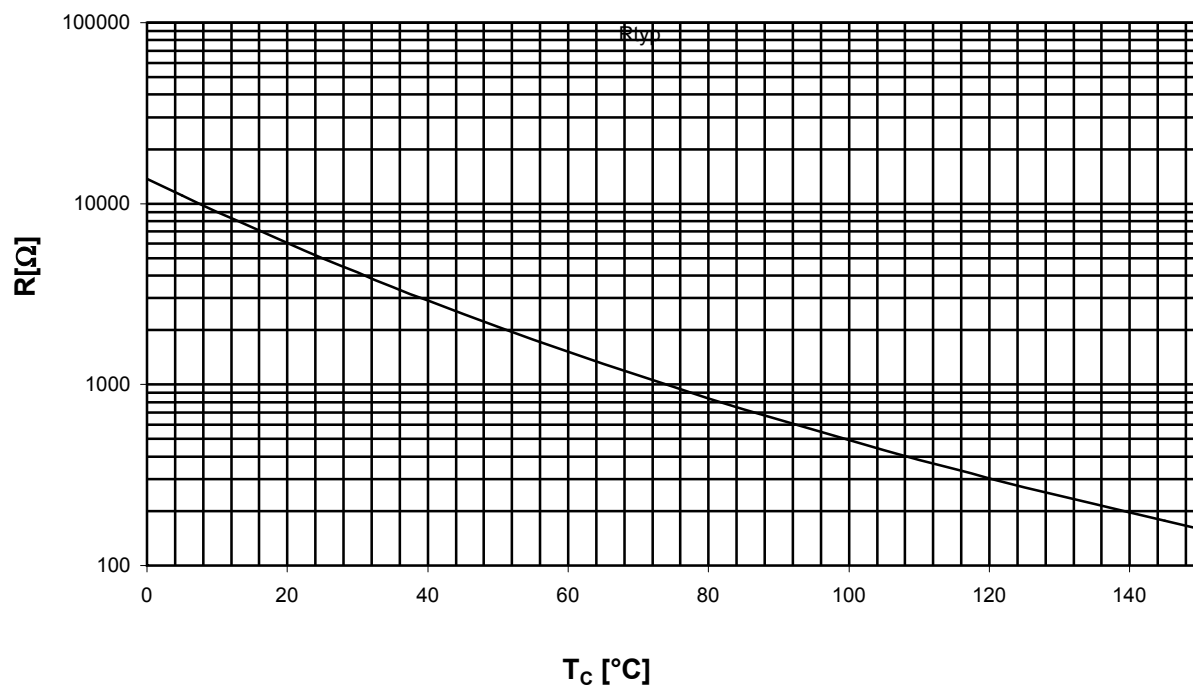
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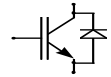
Durchlaßkennlinie der Gleichrichterdiode (typisch)
forward characteristic of rectifier diode (typical)

$$I_F = f(V_F)$$



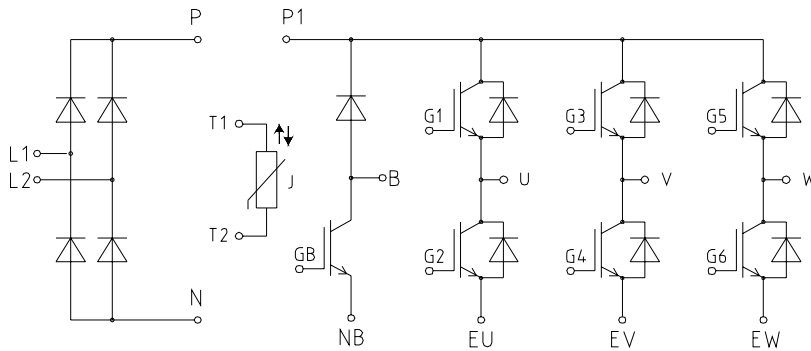
NTC- Temperaturkennlinie (typisch) $R = f(T)$
NTC- temperature characteristic (typical)





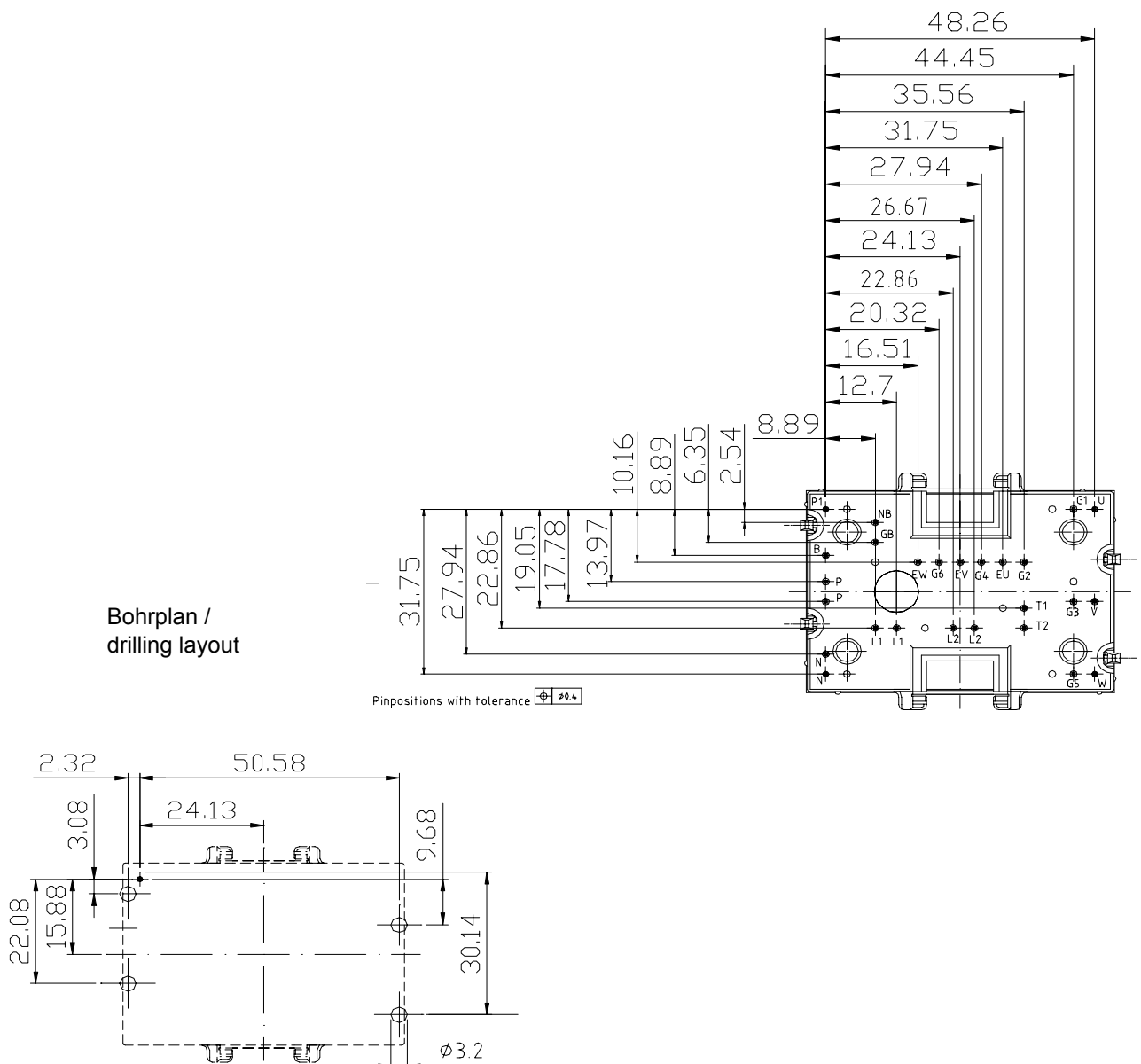
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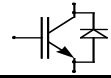
Schaltplan/ circuit diagram



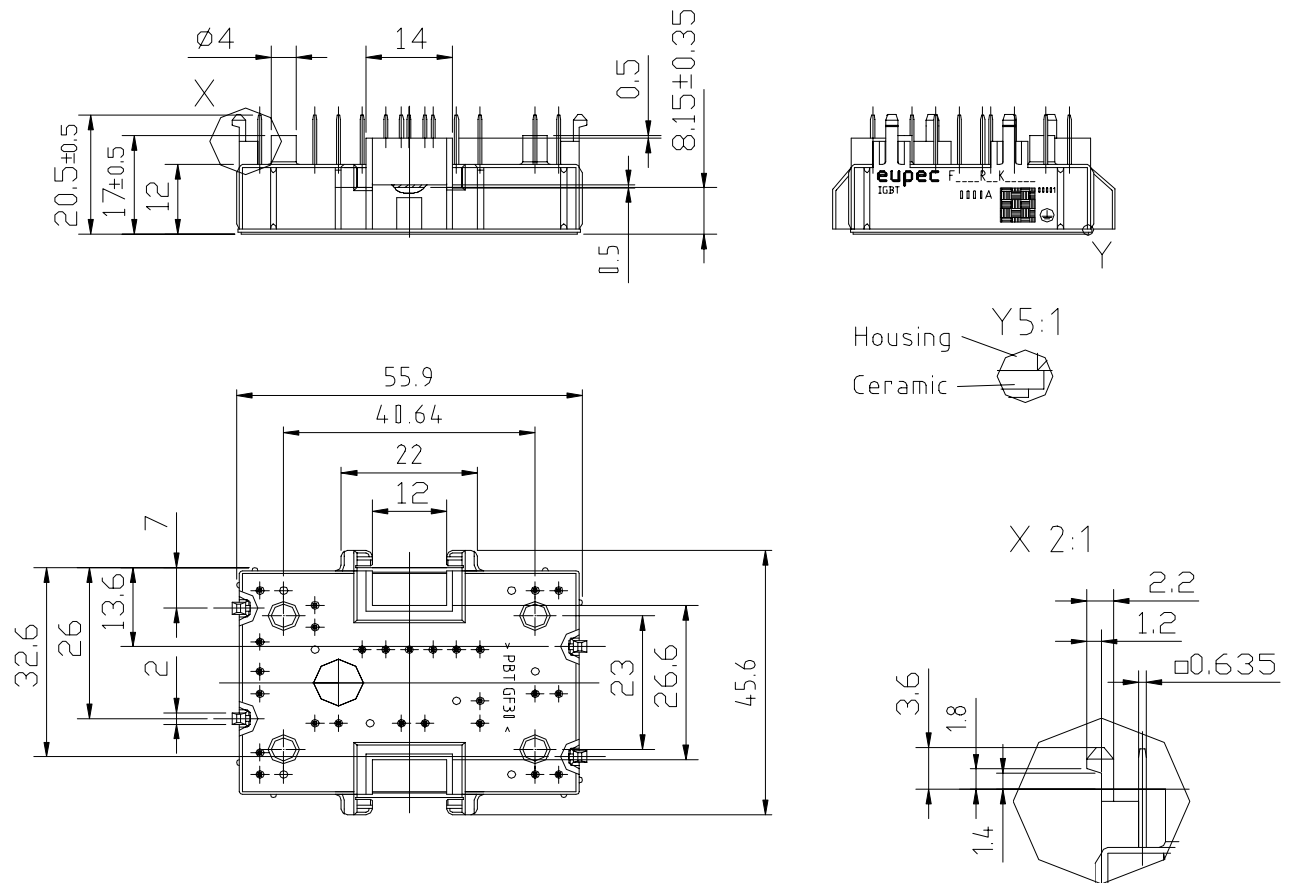
Gehäuseabmessungen/ package outlines

Bohrplan /
drilling layout





Gehäuseabmessungen Forts. / package outlines contd.



Mit dieser technischen Information werden Halbleiterbauelemente spezifiziert, jedoch keine Eigenschaften zugesichert. Sie gilt in Verbindung mit den zugehörigen technischen Erläuterungen.

This technical information specifies semiconductor devices but promises no characteristics. It is valid in combination with the belonging technical note: